



## N-Channel 60-V (D-S) Fast Switching MOSFET

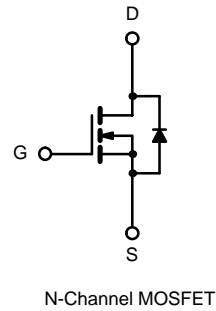
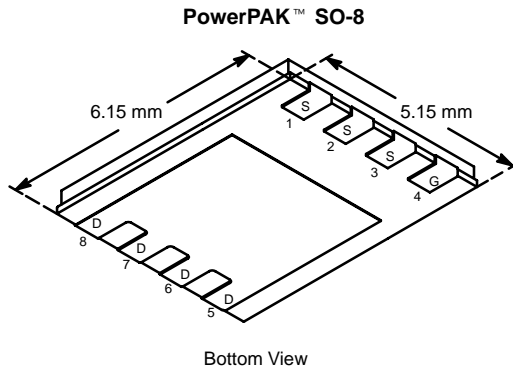
| PRODUCT SUMMARY |                           |           |
|-----------------|---------------------------|-----------|
| $V_{DS}$ (V)    | $r_{DS(on)}$ ( $\Omega$ ) | $I_D$ (A) |
| 60              | 0.022 @ $V_{GS} = 10$ V   | 10.3      |
|                 | 0.031 @ $V_{GS} = 4.5$ V  | 8.7       |

### FEATURES

- TrenchFET® Power MOSFET
- New Low Thermal Resistance PowerPAK™ Package with Low 1.07-mm Profile
- PWM Optimized for Fast Switching

### APPLICATIONS

- Primary Side Switch for 24-V DC/DC Applications
- Secondary Synchronous Rectifier



| ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED) |                |                          |              |                  |   |
|---|----------------|--------------------------|--------------|------------------|---|
| Parameter   | Symbol         | 10 secs                  | Steady State | Unit             |   |
| Drain-Source Voltage  | $V_{DS}$       | 60                       |              | V                |   |
| Gate-Source Voltage   | $V_{GS}$       | $\pm 20$                 |              |                  |   |
| Continuous Drain Current ( $T_J = 150^\circ\text{C}$ ) <sup>a</sup>         | $I_D$          | $T_A = 25^\circ\text{C}$ | 10.3         | 6.2              | A |
|   |                | $T_A = 85^\circ\text{C}$ | 7.5          | 4.5              |   |
| Continuous Source Current   | $I_S$          | 3.7                      | 1.5          |                  |   |
| Pulsed Drain Current  | $I_{DM}$       | 40                       |              |                  |   |
| Avalanche Current <sup>b</sup>  | $I_{AS}$       | 15                       |              |                  |   |
| Single Avalanche Energy <sup>b</sup>  | $E_{AS}$       | 11                       |              | mJ               |   |
| Maximum Power Dissipation <sup>a</sup>                                      | $P_D$          | $T_A = 25^\circ\text{C}$ | 4.5          | 1.8              | W |
|   |                | $T_A = 85^\circ\text{C}$ | 2.3          | 0.9              |   |
| Operating Junction and Storage Temperature Range                            | $T_J, T_{stg}$ | -55 to 150               |              | $^\circ\text{C}$ |   |

| THERMAL RESISTANCE RATINGS               |            |                 |         |      |                    |
|--|------------|-----------------|---------|------|--------------------|
| Parameter                                | Symbol     | Typical         | Maximum | Unit |                    |
| Maximum Junction-to-Ambient <sup>a</sup> | $R_{thJA}$ | $t \leq 10$ sec | 22      | 28   | $^\circ\text{C/W}$ |
|  |            | Steady State    | 58      | 70   |                    |
| Maximum Junction-to-Case (Drain)         | $R_{thJC}$ | 2.6             | 3.3     |      |                    |

Notes

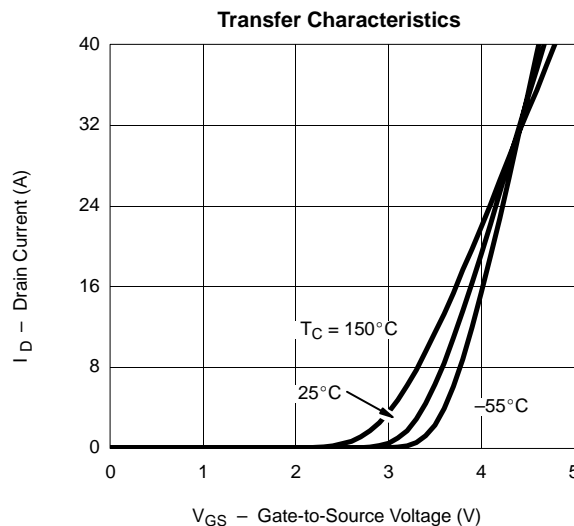
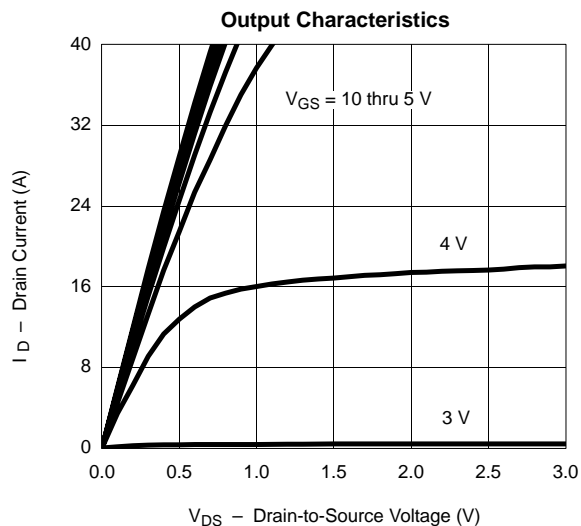
- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Guaranteed by design, not subject to production testing.

| MOSFET SPECIFICATIONS (T <sub>J</sub> = 25 °C UNLESS OTHERWISE NOTED) |                      |  |     |       |       |      |
|---|----------------------|--|-----|-------|-------|------|
| Parameter   | Symbol               | Test Condition   | Min | Typ   | Max   | Unit |
| <b>Static</b>   |                      |  |     |       |       |      |
| Drain-Source Breakdown Voltage  | V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA   | 60  |       |       | V    |
| Gate Threshold Voltage  | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA  | 1   |       |       |      |
| Gate-Body Leakage   | I <sub>GSS</sub>     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V   |     |       | ±100  | nA   |
| Zero Gate Voltage Drain Current                                       | I <sub>DSS</sub>     | V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V  |     |       | 1     | μA   |
|   |                      | V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C  |     |       | 20    |      |
| On-State Drain Current <sup>a</sup>                                   | I <sub>D(on)</sub>   | V <sub>DS</sub> ≥ 5 V, V <sub>GS</sub> = 10 V  | 40  |       |       | A    |
| Drain-Source On-State Resistance <sup>a</sup>                         | r <sub>DS(on)</sub>  | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10.3 A  |     | 0.018 | 0.022 | Ω    |
|   |                      | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 8.7 A  |     | 0.025 | 0.031 |      |
| Forward Transconductance <sup>a</sup>                                 | g <sub>fs</sub>      | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10.3 A  |     | 26    |       | S    |
| Diode Forward Voltage <sup>a</sup>                                    | V <sub>SD</sub>      | I <sub>S</sub> = 3.8 A, V <sub>GS</sub> = 0 V  |     | 0.85  | 1.2   | V    |
| <b>Dynamic<sup>b</sup></b>  |                      |  |     |       |       |      |
| Total Gate Charge   | Q <sub>g</sub>       | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10.3 A  |     | 18    | 27    | nC   |
| Gate-Source Charge  | Q <sub>gs</sub>      |  |     | 3.4   |       |      |
| Gate-Drain Charge   | Q <sub>gd</sub>      |  |     | 5.3   |       |      |
| Gate-Resistance   | R <sub>G</sub>       |  |     | 1.4   |       | Ω    |
| Turn-On Delay Time  | t <sub>d(on)</sub>   | V <sub>DD</sub> = 30 V, R <sub>L</sub> = 30 Ω<br>I <sub>D</sub> ≅ 1 A, V <sub>GEN</sub> = 10 V, R <sub>G</sub> = 6 Ω |     | 10    | 20    | ns   |
| Rise Time   | t <sub>r</sub>       |  |     | 10    | 20    |      |
| Turn-Off Delay Time   | t <sub>d(off)</sub>  |  |     | 25    | 50    |      |
| Fall Time   | t <sub>f</sub>       |  |     | 12    | 24    |      |
| Source-Drain Reverse Recovery Time                                    | t <sub>rr</sub>      | I <sub>F</sub> = 3.8 A, di/dt = 100 A/μs   |     | 50    | 80    |      |

**Notes**

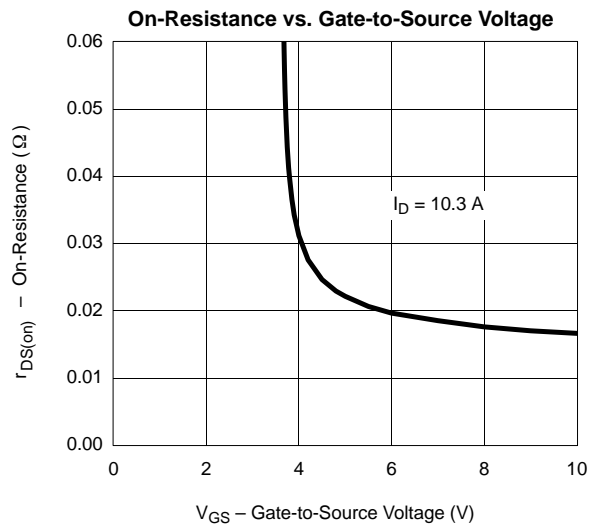
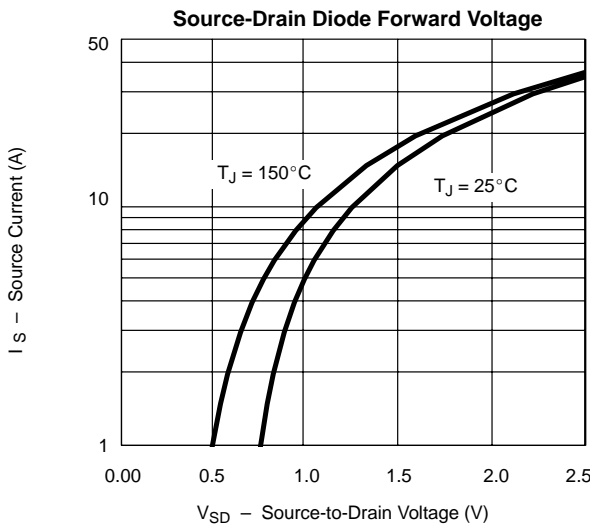
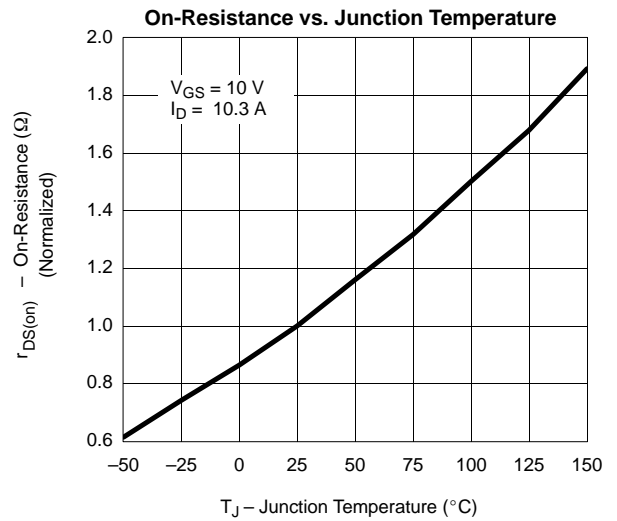
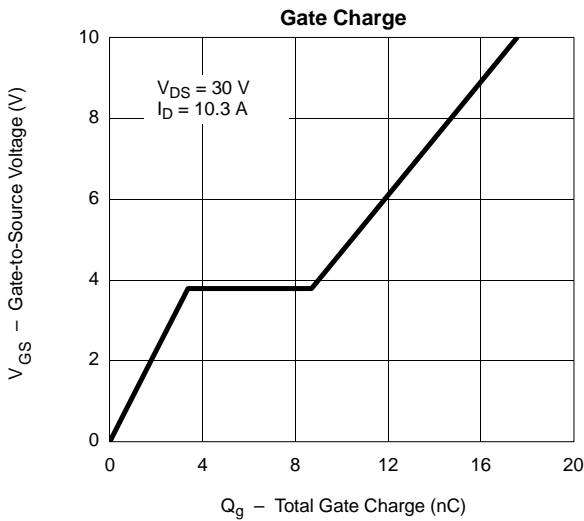
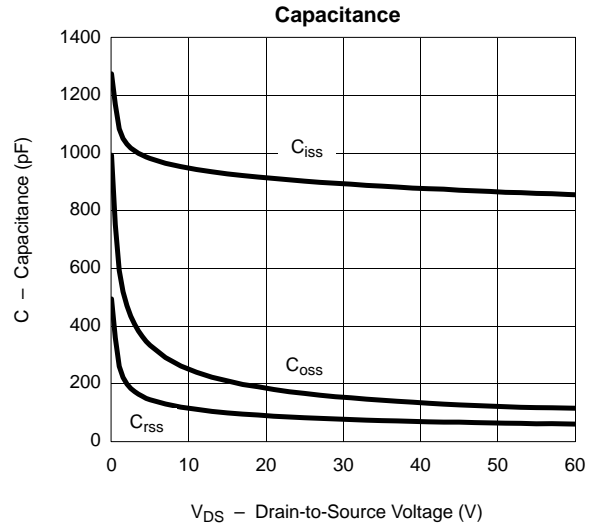
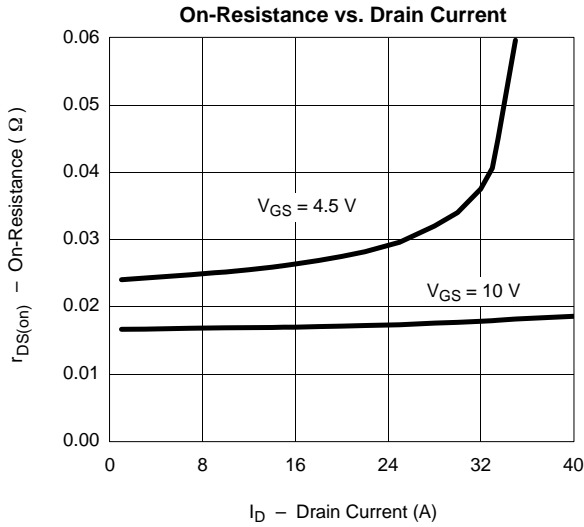
- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
- b. Guaranteed by design, not subject to production testing.

### TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)





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